

## **GROUP ASSIGNMENT**

## **TECHNOLOGY PARK MALAYSIA**

CT077-3-2 DSTR

## **DATA STRUCTURES**

APD2F2209CS(CYB) / APU2F2209CS(CYB) / APU2F2209CS(DA) / APU2F2209CS / APU2F2209CS(IS) / APU2F2209SE / APD2F2209CS(DA) / APD2F2209CS(DF) / APD2F2209CS(DF) / APD2F2209CS

HAND OUT DATE: 17 - MARCH - 2023

HAND IN DATE: 29 – MAY - 2023

**WEIGHTAGE: 50%** 

## **INSTRUCTIONS TO CANDIDATES:**

- 1 Submit your assignment at the Moodle System.
- 2 Students are advised to underpin their answers with the use of references (cited using the APA Style System of Referencing)
- 3 Late submission will be awarded zero (0) unless Extenuating Circumstances (EC) are upheld
- 4 Cases of plagiarism will be penalized
- 5 The assignment should be submitted in softcopy, where the softcopy of the written assignment and source code (where appropriate) should be on Moodle System.
- 7 You must obtain 50% overall to pass this module.